

PACKAGE DIMENSIONS 0.200 (5.08) 0.180 (4.57) 0.350 (8.89) 0.040 (1.02) 0.330 (8.38) **FEATURES** • Popular T-1 3/4 package applications 1.00 (25.4) MIN · Solid state reliability Water clear optics · Standard 100 mil. lead spacing 0.050 (1.27) 0.050 (1.27) RFF 0.100 (2.54) 0.100 (2.54) Ø 0.230 (5.84) REF. FLAT DENOTES 0.023 (0.58) 0.017 (0.43) SQ. TYP. (2X) CATHODE NOTES:

- 1. Dimensions for all drawings are in inches (mm).
- 2. Lead spacing is measured where the leads emerge from the package.
- 3. Protruded resin under the flange is 1.5 mm (0.059") max.

SUPER YELLOW **MV830X** MV8303 MV8304 MV8305 MV8306

- · Super high brightness suitable for outdoor



DESCRIPTION

This T-1 3/4 super bright LED has a moderate viewing angle of 20° for concentrated light output. The MV830X series is made with an AllnGaP LED that emits yellow light at 590 nm. It is encapsulated in a water clear epoxy lens package.

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise specified)						
Parameter	Symbol	Symbol Rating				
Operating Temperature	T _{OPR}	-40 to +100	°C			
Storage Temperature	T _{STG}	-40 to +100	°C			
Lead Soldering Time	T _{SOL}	260 for 5 sec	°C			
Continuous Forward Current	I _F	30	mA			
Peak Forward Current		160	mA			
(f = 1.0 KHz, Duty Factor = 1/10)	'F	100	IIIA			
Reverse Voltage	V _R	5	V			
Power Dissipation	PD	85	mW			



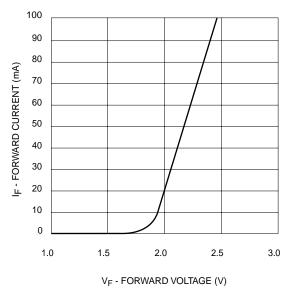
 SUPER YELLOW
 MV830X

 MV8303
 MV8304

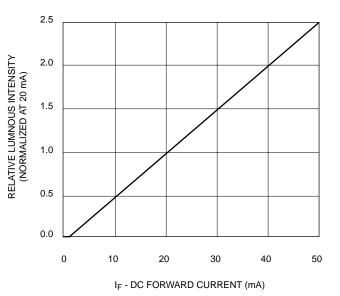
 MV8305
 MV8306

ELECTRICAL / OPTICAL CHARACTERISTICS (TA =25°C)					
Part Number	MV8303	MV8304	MV8305	MV8306	Condition
Luminous Intensity (mcd)					I _F = 20 mA
Minimum	630	1000	1600	2500	
Typical	940	1500	2400	3500	
Forward Voltage (V)					I _F = 20 mA
Maximum	2.8	2.8	2.8	2.8	
Typical	2.1	2.1	2.1	2.1	
Peak Wavelength (nm)	590	590	590	590	I _F = 20 mA
Spectral Line Half Width (nm)	15	15	15	15	I _F = 20 mA
Viewing Angle (°)	20	20	20	20	I _F = 20 mA

TYPICAL PERFORMANCE CURVES











SUPER YELLOW	MV830X
MV8303 MV8304	
MV8305 MV8306	

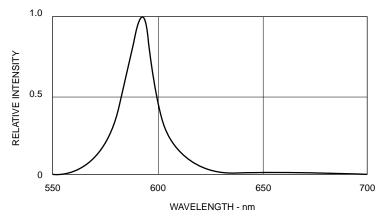


Fig. 3 Relative Intensity vs Peak Wavelength

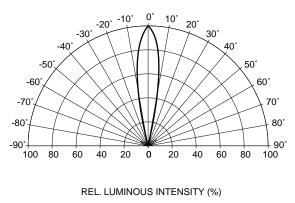
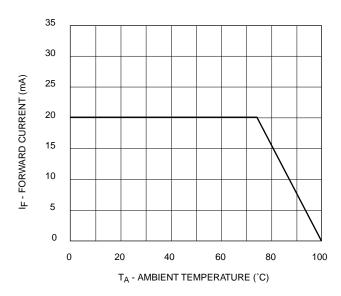


Fig. 4 Radiation Diagram







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